SQJ146ELP

www.vishay.com

Vishay Siliconix

Automotive N-Channel 40 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY				
V _{DS} (V)	40			
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.0058			
$R_{DS(on)} (\Omega)$ at $V_{GS} = 4.5 V$	0.0090			
I _D (A)	88			
Configuration	Single			
Package	PowerPAK SO-8L			

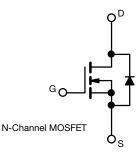
FEATURES

• TrenchFET[®] Gen IV power MOSFET

www.vishay.com/doc?99912

- AEC-Q101 qualified
- 100 % R_g and UIS tested
 Material categorization: for definitions of compliance please see





ABSOLUTE MAXIMUM RATING	$(1_{\rm C} = 25 \text{C}, \text{ unless})$	s otherwise noted	I)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	40	V	
Gate-source voltage		V _{GS}	± 20	v	
Continuous drain surrent	T _C = 25 °C	I	88		
Continuous drain current	T _C = 125 °C	ID	51		
Continuous source current (diode conduction)		I _S	90	А	
Pulsed drain current ^a		I _{DM}	201		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	18		
Single pulse avalanche energy		E _{AS}	16.2	mJ	
Maximum power dissipation ^a	T _C = 25 °C	D	75	w	
	T _C = 125 °C	P _D	25	vv	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C	
Soldering recommendations (peak temperature) ^c		-	260	C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient	PCB mount ^b	R _{thJA}	42	°C/W	
Junction-to-case (drain)		R _{thJC}	1.4	0/10	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. When mounted on 1" square PCB (FR4 material)

c. See solder profile (<u>www.vishay.com/doc?73257</u>). The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

1

www.vishay.com

Vishay Siliconix

SQJ146ELP

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static					•		
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0, I_D = 250 \ \mu A$		40	-	-	v
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	V _{DS} = V _{GS} , I _D = 250 μA		1.7	2.2	v
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	-	± 100	nA
Zero gate voltage drain current		$V_{GS} = 0 V$	V _{DS} = 40 V	-	-	1	μA
	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 40 V, T _J = 125 °C	-	-	50	
		$V_{GS} = 0 V$	V _{DS} = 40 V, T _J = 175 °C	-	-	250	
On-state drain current ^a	I _{D(on)}	$V_{GS} = 10 V$	$V_{DS} \ge 5 V$	30	-	-	Α
		V _{GS} = 10 V	I _D = 15 A	-	0.0043	0.0058	
	P	$V_{GS} = 10 V$	I _D = 15 A, T _J = 125 °C	-	-	0.0115	Ω
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 15 A, T _J = 175 °C	-	-	0.014	
		$V_{GS} = 4.5 V$		-	0.068	0.0090	
Forward transconductance b	9 _{fs}	V _{DS} = 15 V, I _D = 10 A		-	52	-	S
Dynamic ^b	•	•		•	•	•	
Input capacitance	C _{iss}		V _{DS} = 25 V, f = 1 MHz	-	1270	1780	pF
Output capacitance	C _{oss}	$V_{GS} = 0 V$		-	380	630	
Reverse transfer capacitance	C _{rss}				45	65	
Total gate charge ^c	Qg			-	23	35	
Gate-source charge ^c	Q _{gs}	$V_{GS} = 10 V$	V _{GS} = 10 V V _{DS} = 20 V, I _D = 10 A		4	-	nC
Gate-drain charge ^c	Q _{gd}			-	5	-	
Gate resistance	R _g	f = 1 MHz		1.7	3.5	5.3	Ω
Turn-on delay time ^c	t _{d(on)}	$V_{DD} = 20 \text{ V}, \text{ R}_{\text{L}} = 1.0 \Omega$ $\text{I}_{\text{D}} \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		-	10	15	ns
Rise time ^c	tr			-	5	9	
Turn-off delay time ^c	t _{d(off)}			-	24	36	
Fall time ^c	t _f			-	5	9	
Source-Drain Diode Ratings and Chara	acteristics ^b				•		
Pulsed current ^a	I _{SM}			-	-	360	Α
Forward voltage	V _{SD}	I _F = 10 A, V _{GS} = 0 V		-	-	1.1	V
Body diode reverse recovery time	t _{rr}	I _F = 6 A, dl/dt = 100 A/μs		-	21	42	ns
Body diode reverse recovery charge	Q _{rr}			-	8	16	nC
Reverse recovery fall time	t _a			-	10	-	
Reverse recovery rise time	t _b			-	11	-	ns
Body diode peak reverse recovery current	I _{RM(REC)}			-	0.7	-	А

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

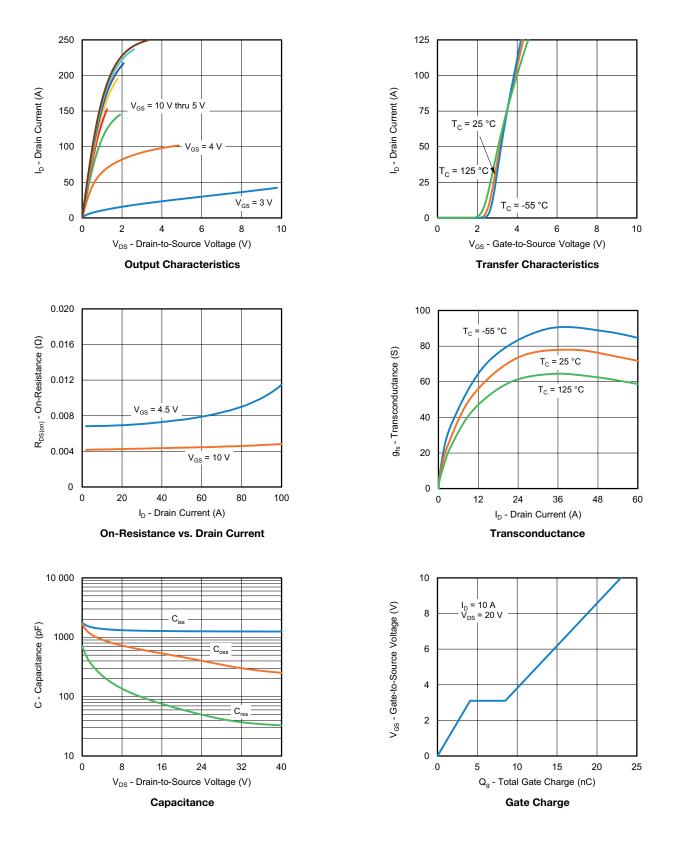
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2



Vishay Siliconix

TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



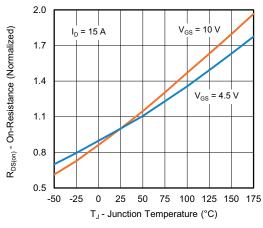
3

For technical questions, contact: <u>automostechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>

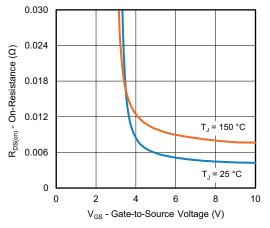


Vishay Siliconix

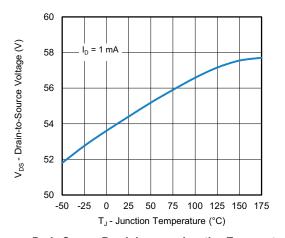
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



On-Resistance vs. Junction Temperature

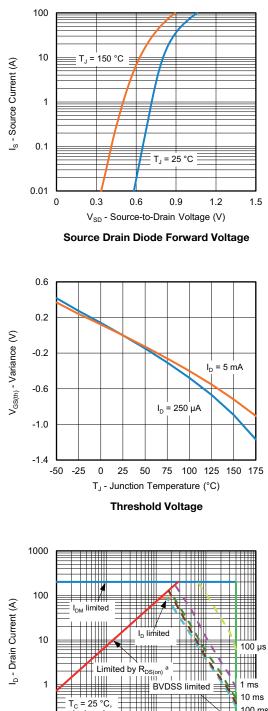


On-Resistance vs. Gate-to Source Voltage



Drain Source Breakdown vs. Junction Temperature Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified



 $T_{c} = 25 \circ C$, $T_{c} = 25$

S20-0725-Rev. B, 28-Sep-2020

4

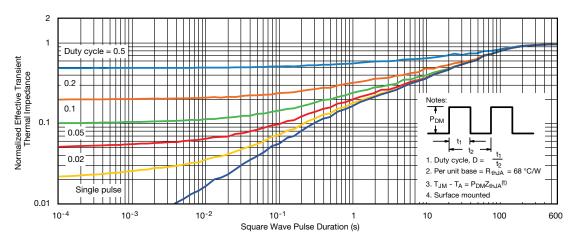
Document Number: 77553

For technical questions, contact: <u>automostechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>

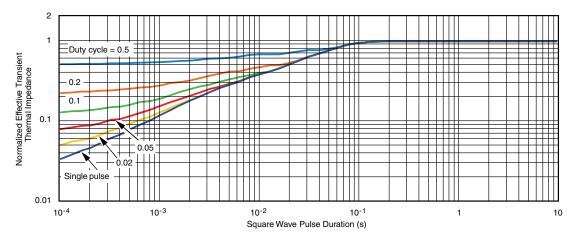


Vishay Siliconix

TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Note

• The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?77553.

S20-0725-Rev. B, 28-Sep-2020	5	Document Number: 77553		
For technical questions, contact: automostechsupport@vishay.com				
THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT				
ARE SUBJEC	CT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishav.com	<u>1/doc?91000</u>		



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFETs category:

Click to view products by Vishay manufacturer:

Other Similar products are found below :

MCH3443-TL-E MCH6422-TL-E NTNS3A92PZT5G IRFD120 JANTX2N5237 2SK2464-TL-E 2SK3818-DL-E 2SJ277-DL-E 2SK2267(Q) BUK455-60A/B BUZ80 TK100A10N1,S4X(S MIC4420CM-TR IRFS350 VN1206L NDP4060 IPS70R2K0CEAKMA1 AON6932A TS19452CS RL TK31J60W5,S1VQ(O 2SK2614(TE16L1,Q) JANTX2N6798 DMN1017UCP3-7 EFC2J004NUZTDG DMN1053UCP4-7 SCM040600 NTE2384 2N7000TA DMN2080UCB4-7 DMN61D9UWQ-13 US6M2GTR DMN31D5UDJ-7 DMP22D4UFO-7B DMN1006UCA6-7 DMN16M9UCA6-7 STF5N65M6 IRF40H233XTMA1 STU5N65M6 DMN6022SSD-13 DMN13M9UCA6-7 DMTH10H4M6SPS-13 DMN2990UFB-7B 2N7002W-G MCAC30N06Y-TP MCQ7328-TP IPB45P03P4L11ATMA2 BXP4N65F BXP2N20L BXP2N65D TSM60NB380CP ROG